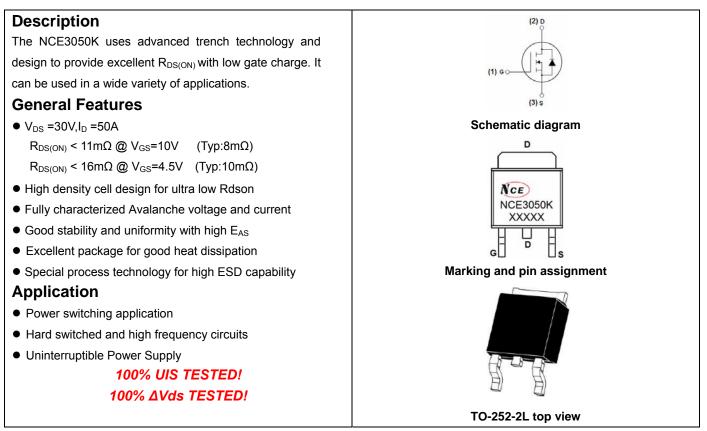


# NCE N-Channel Enhancement Mode Power MOSFET



### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE3050K	NCE3050K	TO-252-2L	-	-	-

### Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	Ι <sub>D</sub>	50	A
Drain Current-Continuous(T <sub>C</sub> =100℃)	I <sub>D</sub> (100℃)	35.4	А
Pulsed Drain Current	I <sub>DM</sub>	200	А
Maximum Power Dissipation	PD	60	W
Derating factor		0.4	W/°C
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	100	mJ
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 175	°C

### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	R <sub>θJC</sub>	2.5	°C/W

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### Electrical Characteristics (T $_{c}$ =25 $^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	30	33	-	V	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V	-	-	1	μA	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA	
On Characteristics (Note 3)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250µA	1	1.6	2.6	V	
Drain Source On State Registeres	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	8	11		
Drain-Source On-State Resistance		V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A	-	10	16	mΩ	
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =5V,I <sub>D</sub> =20A		20	-	S	
Dynamic Characteristics (Note4)							
Input Capacitance	C <sub>lss</sub>		-	2000	-	PF	
Output Capacitance	Coss	V <sub>DS</sub> =15V,V <sub>GS</sub> =0V, F=1.0MHz	-	280	-	PF	
Reverse Transfer Capacitance	C <sub>rss</sub>		-	210	-	PF	
Switching Characteristics (Note 4)		·					
Turn-on Delay Time	t <sub>d(on)</sub>		-	10	-	nS	
Turn-on Rise Time	tr	V <sub>DD</sub> =15V,I <sub>D</sub> =20A	-	8	-	nS	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{GEN}$ =1.8 $\Omega$	-	25	-	nS	
Turn-Off Fall Time	t <sub>f</sub>		-	5	-	nS	
Total Gate Charge	Qg	V -10V(L-20A	-	32.3	-	nC	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =10V,I <sub>D</sub> =20A, V <sub>GS</sub> =10V	-	4.9	-	nC	
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	6.9	-	nC	
Drain-Source Diode Characteristics	·	·					
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =20A	-	0.85	1.2	V	
Diode Forward Current (Note 2)	ls		-	-	50	Α	
Reverse Recovery Time	trr	TJ = 25°C, I <sub>F</sub> = 20A	-	-	27	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>	-	-	20	nC	
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)					

#### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

**2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.

**3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.

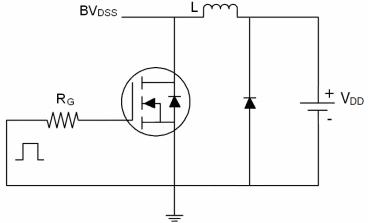
4. Guaranteed by design, not subject to production

5. EAS condition: Tj=25 $^\circ\!\mathrm{C},$  V\_DD=15V,V\_G=10V,L=0.5mH, Rg=25 $\Omega$ 

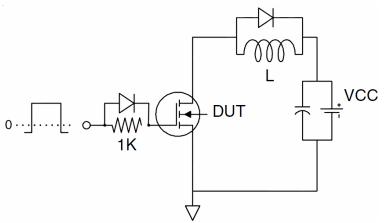


# **Test circuit**

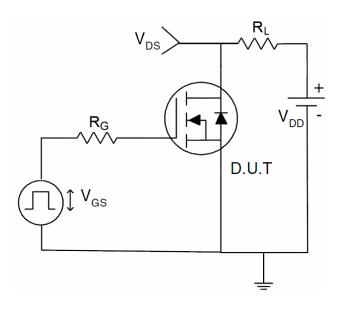
1) E<sub>AS</sub> test Circuits



2) Gate charge test Circuit:

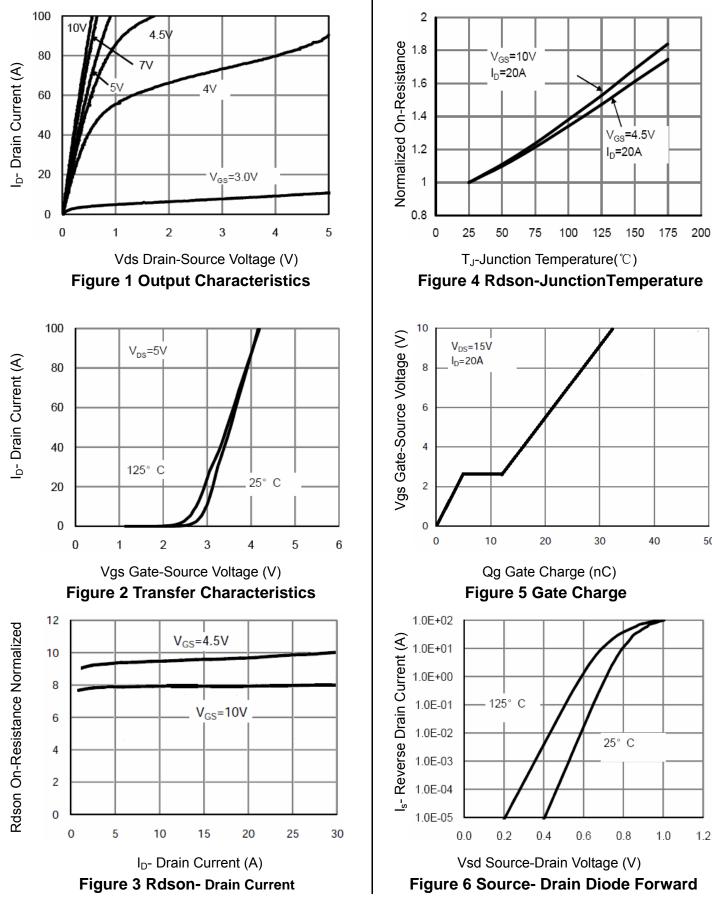


3) Switch Time Test Circuit:





### **Typical Electrical and Thermal Characteristics (Curves)**



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# NCE3050K

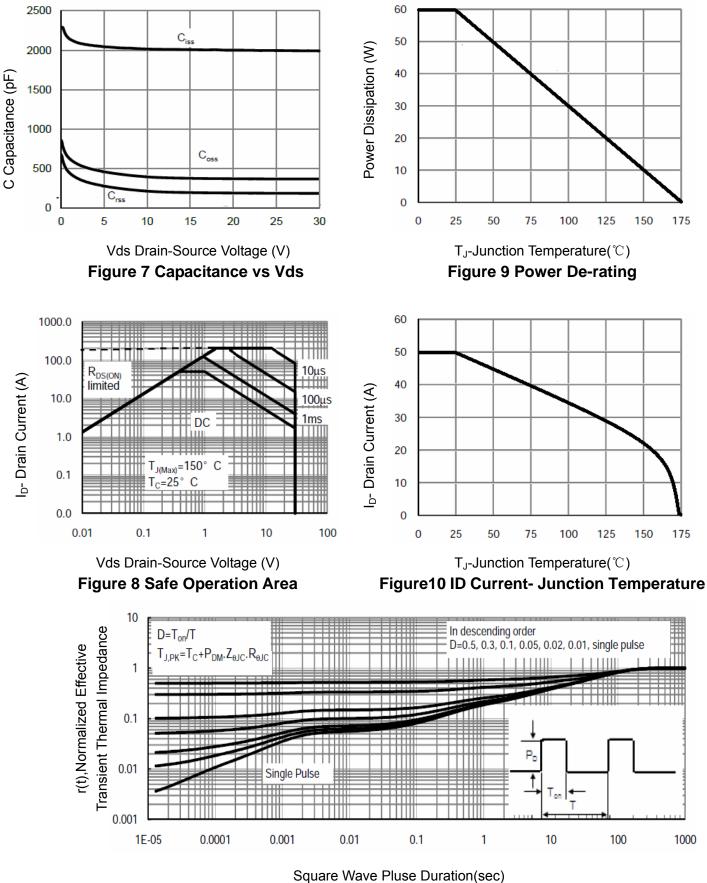
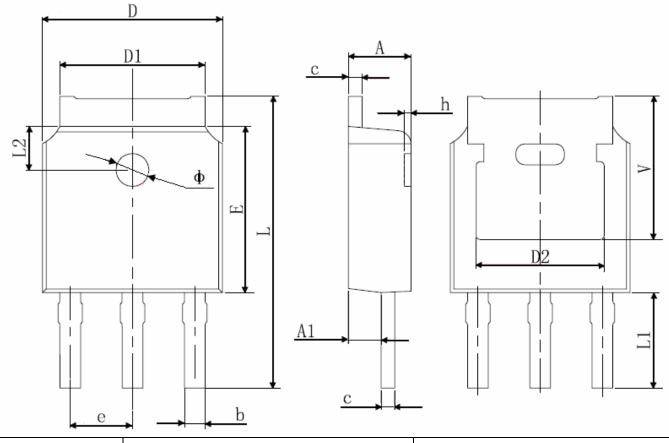


Figure 11 Normalized Maximum Transient Thermal Impedance



# **TO-251S Package Information**



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
A	2.200	2.400	0.087	0.094	
A1	0.860	1.160	0.034	0.046	
b	0.660	0.860	0.026	0.034	
с	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.830	REF.	0.190 REF.		
E	6.000	6.200	0.236	0.244	
e	2.186	2.386	0.086	0.094	
L	10.400	11.000	0.409	0.433	
L1	3.300	3.700	0.130	0.146	
L2	1.600	REF.	0.063 REF.		
Φ	1.100	1.300	0.043	0.051	
h	0.000	0.300	0.000	0.012	
V	5.350	REF.	0.211 REF.		



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